



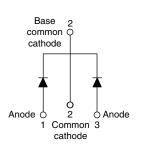
Vishay Semiconductors

HALOGEN

FREE

Schottky Rectifier, 2 x 20 A

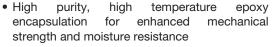




PRODUCT SUMMARY					
Package	TO-220AB				
I _{F(AV)}	2 x 20 A				
V _R	20 V				
V _F at I _F	0.34 V				
I _{RM} max.	310 mA at 125 °C				
T _J max.	150 °C				
Diode variation	Common cathode				
E _{AS}	18 mJ				

FEATURES

- 150 °C T_J operation
- Optimized for 3.3 V application
- Ultralow forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability





- Designed and qualified according to JEDEC-JESD47
- Halogen-free according to IEC 61249-2-21 definition (-N3 only)



This center tap Schottky rectifier has been optimized for ultralow forward voltage drop specifically for 3.3 V output power supplies. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, reverse battery protection, and redundant power subsystems.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I _{F(AV)}	Rectangular waveform	40	А			
V_{RRM}		20	V			
I _{FSM}	t _p = 5 μs sine	1000	А			
V _F	20 A _{pk} , T _J = 125 °C	0.34	V			
T_J		- 55 to 150	°C			

VOLTAGE RATINGS						
PARAMETER	SYMBOL	VS-47CTQ020PbF	VS-47CTQ020-N3	UNITS		
Maximum DC reverse voltage	V _R	20	20	V		
Maximum working peak reverse voltage	V_{RWM}	20	20	V		

ABSOLUTE MAXIMUM RATINGS						
PARAMETER		SYMBOL	TEST COND	ITIONS	VALUES	UNITS
Maximum average	per leg			50.0/ duty sugle at T = 105.00 restance and a respective		
forward current per device		I _{F(AV)}	50 % duty cycle at T _C = 135 °C, rectangular waveform		40	
Maximum peak one cycle non-repetitive surge current per leg		I _{FSM}	5 μs sine or 3 μs rect. pulse	Following any rated load condition and with rated	1000	Α
			10 ms sine or 6 ms rect. pulse	V _{RRM} applied	250	
Non-repetitive avalanche energy per leg		E _{AS}	T _J = 25 °C, I _{AS} = 3 A, L = 3 mH		18	mJ
Repetitive avalanche current per leg		I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T_J maximum $V_A = 1.5 \times V_R$ typical		3	Α

VS-47CTQ020PbF, VS-47CTQ020-N3

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ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
		20 A	T 05 °C	0.45		
		40 A	$T_J = 25 ^{\circ}\text{C}$	0.51		
Marian conference de la	v (1)	20 A	T 105 °C	0.34	V	
Maximum forward voltage drop per leg	V _{FM} ⁽¹⁾	40 A	T _J = 125 °C	0.44	V	
		20 A	T 450 00	0.31		
		40 A	T _J = 150 °C	0.42		
	I _{RM} ⁽¹⁾	T _J = 125 °C	V _R = 5 V	60		
			V _R = 3.3 V	45		
Maximum reverse leakage current per leg		T _J = 150 °C	V _R = 10 V	306	mA	
		T _J = 25 °C	V Detectiv	3		
		T _J = 125 °C	V _R = Rated V _R	310		
Threshold voltage	V _{F(TO)}	T _J = T _J maximum		0.188	V	
Forward slope resistance	r _t			5.9	mΩ	
Maximum junction capacitance per leg	C _T	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz) 25 °C		3000	pF	
Typical series inductance per leg	L _S	Measured lead to lead 5 mm from package body		5.5	nH	
Maximum voltage rate of change	dV/dt	Rated V _R		10 000	V/µs	

Note

 $^{^{(1)}\,}$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction and storage temperature range	Э	T _J , T _{Stg}		- 55 to 150	°C		
Maximum thermal resistance, junction to case per leg		В	DC eneration	1.5			
Maximum thermal resistance, junction to case per package		R _{thJC}	DC operation	0.75	°C/W		
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.50]		
Approximate weight				2	g		
Approximate weight				0.07	oz.		
Mounting torque	minimum			6 (5)	kgf · cm		
Mounting torque -	maximum			12 (10)	(lbf \cdot in)		
Marking device			Case style TO-220AB	47CT	Q020		

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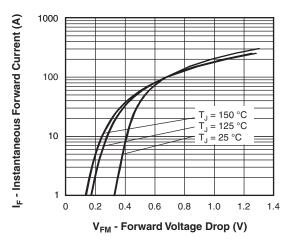


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

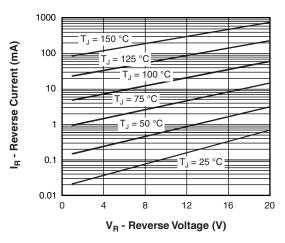


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

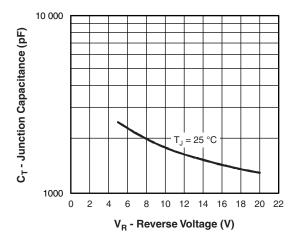


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

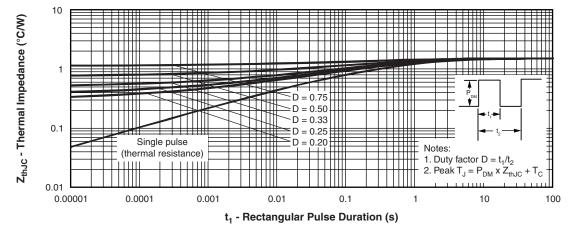


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)



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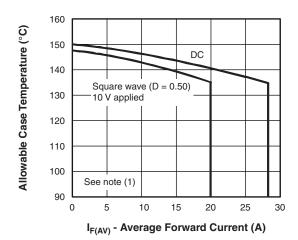


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

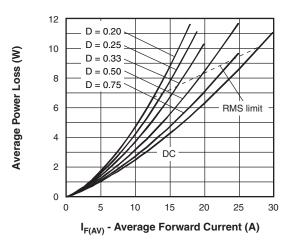


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

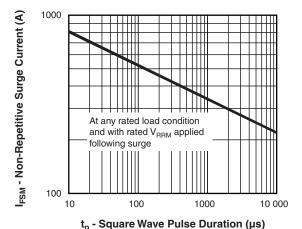


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

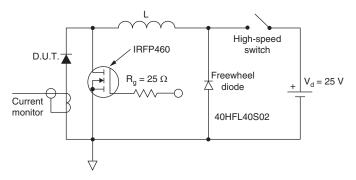


Fig. 8 - Unclamped Inductive Test Circuit

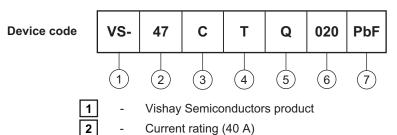
Note

 $^{(1)}$ Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC};$ $Pd = Forward power loss = I_{F(AV)} \times V_{FM}$ at (I_{F(AV)}/D) (see fig. 6); $Pd_{REV} = Inverse power loss = V_{R1} \times I_R (1 - D); I_R at V_{R1} = 10 \ V$

VS-47CTQ020PbF, VS-47CTQ020-N3

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ORDERING INFORMATION TABLE



Circuit configuration
C = Common cathode

- Package T = TO-220

0 1 111 "0"

Schottky "Q" seriesVoltage rating (020 = 20 V)

7 - Environmental digit

• PbF = Lead (Pb)-free and RoHS compliant

• -N3 = Halogen-free, RoHS compliant, and totally lead (Pb)-free

ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-47CTQ020PbF	50	1000	Antistatic plastic tube				
VS-47CTQ020-N3	50	1000	Antistatic plastic tube				

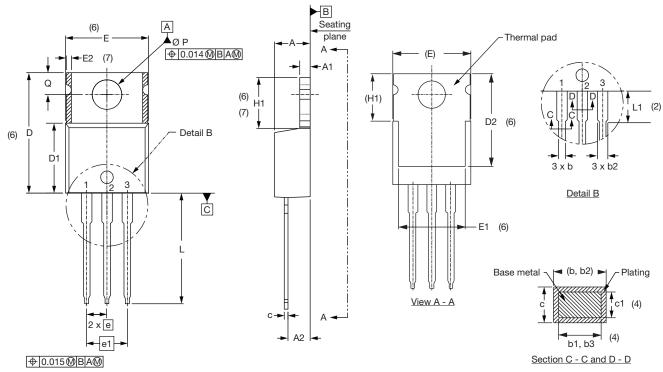
LINKS TO RELATED DOCUMENTS				
Dimensions <u>www.vishay.com/doc?95222</u>				
Deut eranding information	TO-220AB PbF	www.vishay.com/doc?95225		
Part marking information	TO-220AB -N3	www.vishay.com/doc?95028		



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TO-220AB

DIMENSIONS in millimeters and inches



<u>Lead assignments</u> <u>Diodes</u>



- 1. Anode/open
- 2. Cathode
- 3. Anode

Conforms to JEDEC outline TO-220AB

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.56	2.92	0.101	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
С	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.25	0.585	0.600	3
D1	8.38	9.02	0.330	0.355	
D2	11.68	12.88	0.460	0.507	6

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STIMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
E	10.11	10.51	0.398	0.414	3, 6
E1	6.86	8.89	0.270	0.350	6
E2	-	0.76	-	0.030	7
е	2.41	2.67	0.095	0.105	
e1	4.88	5.28	0.192	0.208	
H1	6.09	6.48	0.240	0.255	6, 7
L	13.52	14.02	0.532	0.552	
L1	3.32	3.82	0.131	0.150	2
ØΡ	3.54	3.73	0.139	0.147	
Q	2.60	3.00	0.102	0.118	
θ	90° t	o 93°	90° t	o 93°	

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimensions: inches
- 6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimensions E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC TO-220, except A2 (maximum) and D2 (minimum) where dimensions are derived from the actual package outline



Legal Disclaimer Notice

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